MOSFET – Power, N-Channel, **SUPERFET III, Easy Drive**

650 V, 6 A, 600 mΩ

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

Features

- 700 V @ T_J = 150°C
- Typ. $R_{DS(on)} = 493 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 11 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 127 pF)
- 100% Avalanche Tested
- are RoHS • These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Computing / Display Power Supplies
- Telecom / Server Power Supplies
- Industrial Power Supplies
- Lighting / Charger / Adapter



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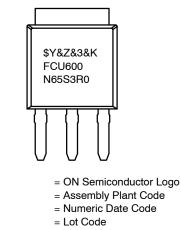
V _{DSS}	R _{DS(ON)} MAX	I _D MAX
650 V	600 mΩ @ 10 V	6 A



N-Channel MOSFET

(DPAK3 STRAIGHT LEADS) CASE 369AP

MARKING DIAGRAM



&K FCU600N65S3R0 = Specific Device Code

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ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit	
V _{DSS}	Drain to Source Voltage	Drain to Source Voltage		V
V _{GSS}	Gate to Source Voltage	DC	±30	V
		AC (f > 1 Hz)	±30	V
ID	Drain Current	Continuous (T _C = 25°C)	6	А
	Continuous (T _C = 100°C)		3.8	
I _{DM}	Drain Current	Pulsed (Note 1)		А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		24	mJ
I _{AS}	Avalanche Current (Note 2)		1.6	А
E _{AR}	Repetitive Avalanche Energy (Note 1)	petitive Avalanche Energy (Note 1)		mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
PD	Power Dissipation	(T _C = 25°C)	54	W
	Derate Above 25°C		0.43	W/∘C
T _J , T _{STG}	Operating and Storage Temperature Range		–55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8	" from Case for 5 s	300	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

THERMAL CHARACTERISTICS

TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s	ximum Lead Temperature for Soldering, 1/8" from Case for 5 s				
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 1.6 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \leq 3 \text{ A}$, di/dt $\leq 200 \text{ A}/\mu\text{s}$, $V_{DD} \leq 400 \text{ V}$, starting $T_J = 25^{\circ}\text{C}$. THERMAL CHARACTERISTICS						
Symbol	Parameter	Value	Unit			
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2.3	°C/W			
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	100				

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Shipping (Qty / Packing)
FCU600N65S3R0	FCU600N65S3R0	I–PAK (DPAK3 STRAIGHT LEADS) (Pb–Free / Halogen Free)	75 Units / Tube
	PLEPRES		

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit	
OFF CHARACT	FF CHARACTERISTICS						
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650	-	-	V	
		V_{GS} = 0 V, I _D = 1 mA, T _J = 150°C	700	-	-	V	
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to $25^{\circ}C$	-	0.66	-	V/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 650 V, V _{GS} = 0 V	-	-	1	μΑ	
		$V_{DS} = 520 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	0.3	-		
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	±100	nA	
ON CHARACTE	RISTICS						
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 0.12 \text{ mA}$	2.5	-	4.5	V	
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 3 A	-	493	600	mΩ	

ac(iii)	•							
R _{DS(on)}	Static Drain to Source On Resistance	V_{GS} = 10 V, I _D = 3 A			-	493	600	mΩ
9fs	Forward Transconductance	V_{DS} = 20 V, I_D = 3 A			-	3.6	I	S
DYNAMIC CHARACTERISTICS								

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V _{DS} = 400 V, V _{GS} = 0 V, f = 1 MHz	-	465	-	pF
C _{oss}	Output Capacitance		-0	10	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		127	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	$V_{DS} = 0 \text{ V} \text{ to } 400 \text{ V}, V_{GS} = 0 \text{ V}$	-	17	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 3 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$		11	-	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	<u> </u>	3	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	4.9	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	_	0.9	-	Ω

SWITCHING CHARACTERISTICS

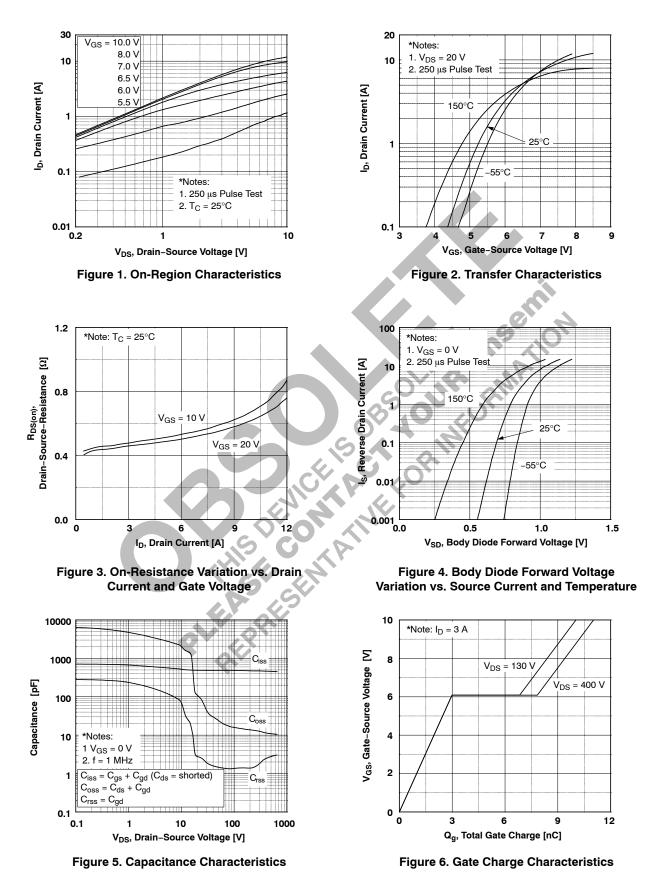
t _{d(on)}	Turn-On Delay Time $V_{DD} = 400 V, I_D = 3 A,$	-	11	-	ns
t _r	Turn-On Rise Time $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$ (Note 4)	-	9	-	ns
t _{d(off)}	Turn-Off Delay Time	-	29	-	ns
t _f	Turn-Off Fall Time	-	14	-	ns

SOURCE-DRAIN DIODE CHARACTERISTICS

۱ _S	Maximum Continuous Source to Drain Diode Forward Current		-	-	6	А
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current		_	-	15	Α
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 3 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 3 A, dI _F /dt = 100 A/μs	-	198	-	ns
Q _{rr}	Reverse Recovery Charge	αι _F /αι = 100 Α/μs	_	1.6	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

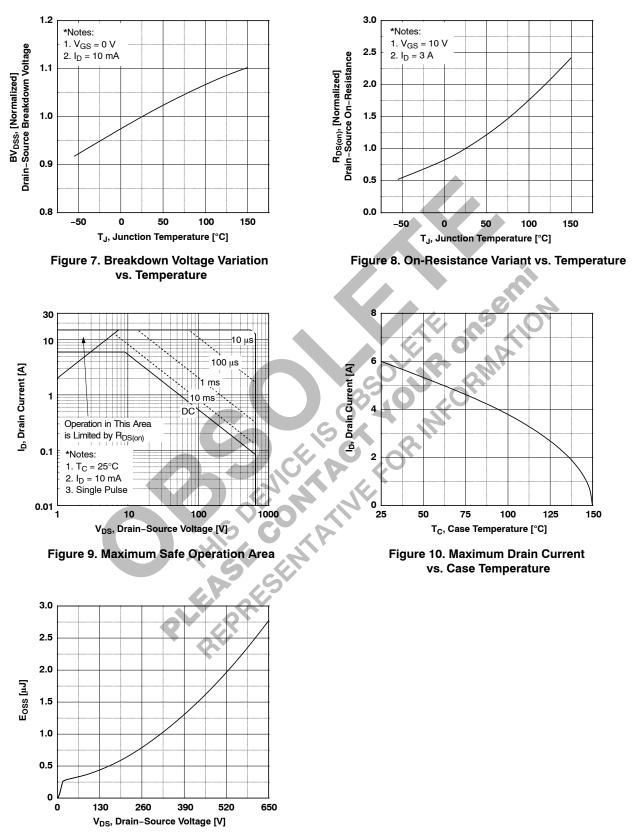
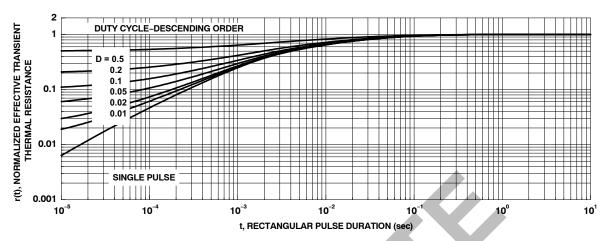
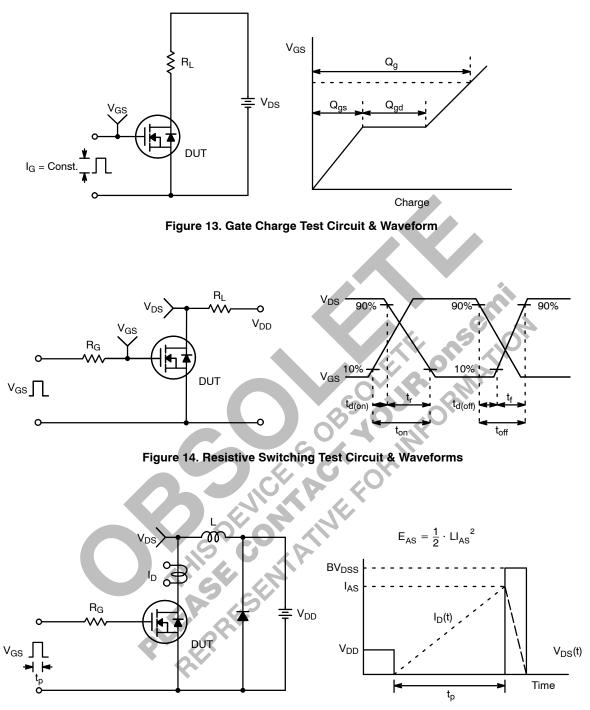


Figure 11. E_{OSS} vs. Drain to Source Voltage

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)









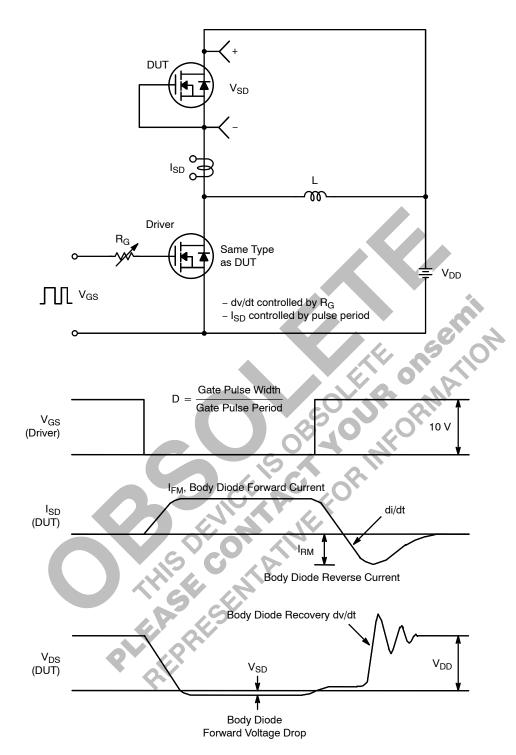


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

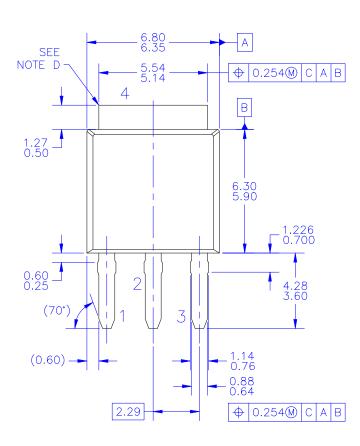
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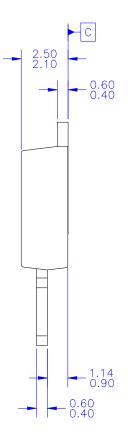


DPAK3 (STRAIGHT LEADS) CASE 369AP

ISSUE O

DATE 30 SEP 2016





NOTES: UNLESS OTHERWISE SPECIFIED

- A) ALL DIMENSIONS ARE IN MILLIMETERS.
- B) PACKAGE BODY REFERENCE: JEDEC, TO-251, ISSUE D, VARIATION AA, DATED JUNE 2002.
- C) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- D) HEAT SINK TOP EDGE COULD BE IN CHAMFERED CORNERS OR EDGE PROTRUSION.

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